# RENESAS HD74ALVCH162721

3.3-V 20-bit Flip Flops with 3-state Outputs

REJ03D0044-0400Z (Previous ADE-205-184B (Z) ) Rev.4.00 Oct.02.2003

#### Description

The HD74ALVCH162721's twenty flip flops are edge triggered D-type flip flops with qualified clock storage. On the positive transition of the clock (CLK) input, the device provides true data at the Q outputs, provided that the clock enable ( $\overline{\text{CLKEN}}$ ) input is low. If  $\overline{\text{CLKEN}}$  is high, no data is stored. A buffered output enable ( $\overline{\text{OE}}$ ) input can be used to place the twenty outputs in either a normal logic state (high or low level) or a high impedance state. In the high impedance state, the outputs neither load nor drive the bus lines significantly. The high impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components. The output enable ( $\overline{\text{OE}}$ ) input does not affect the internal operation of the flip flops. Old data can be retained or new data can be entered while the outputs are in the high impedance state. Active bus hold circuitry is provided to hold unused or floating data inputs at a valid logic level. All outputs, which are designed to sink up to 12 mA, include 26  $\Omega$  resistors to reduce overshoot and undershoot.

#### Features

- $V_{CC} = 2.3 \text{ V}$  to 3.6 V
- Typical V<sub>OL</sub> ground bounce < 0.8 V (@V<sub>CC</sub> = 3.3 V, Ta = 25°C)
- Typical V<sub>OH</sub> undershoot > 2.0 V (@V<sub>CC</sub> = 3.3 V, Ta =  $25^{\circ}$ C)
- High output current  $\pm 12 \text{ mA} (@V_{CC} = 3.0 \text{ V})$
- Bus hold on data inputs eliminates the need for external pullup / pulldown resistors
- All outputs have equivalent 26  $\Omega$  series resistors, so no external resistors are required.



### **Function Table**

Inputs		Output Q			
ŌĒ	CLKEN	CLK	D		
L	Н	Х	Х	$Q_0^{*1}$	
L	L	$\uparrow$	Н	Н	
L	L	$\uparrow$	L	L	
L	L	L or H	Х	Q <sub>0</sub> <sup>*1</sup>	
Н	Х	Х	Х	Z	
11 12 1	. 1				

H : High level

L : Low level

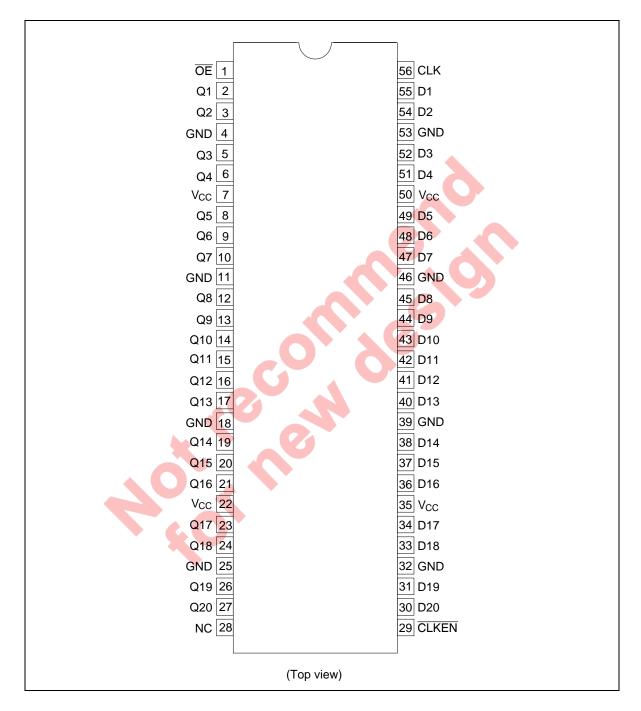
X : Immaterial

Z : High impedance ↑ : Low to high transition

Note: 1. Output level before the indicated steady state input conditions were established.



#### **Pin Arrangement**





#### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CC</sub>	–0.5 to 4.6	V	
Input voltage *1	VI	–0.5 to 4.6	V	
Output voltage *1, 2	Vo	–0.5 to V <sub>CC</sub> +0.5	V	
Input clamp current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> < 0
Output clamp current	I <sub>OK</sub>	±50	mA	$V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}$
Continuous output current	lo	±50	mA	$V_{\rm O}$ = 0 to $V_{\rm CC}$
V <sub>CC</sub> , GND current / pin	$I_{CC}$ or $I_{GND}$	±100	mA	
Maximum power dissipation at Ta = $55^{\circ}$ C (in still air) <sup>*3</sup>	P <sub>T</sub>	1	W	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

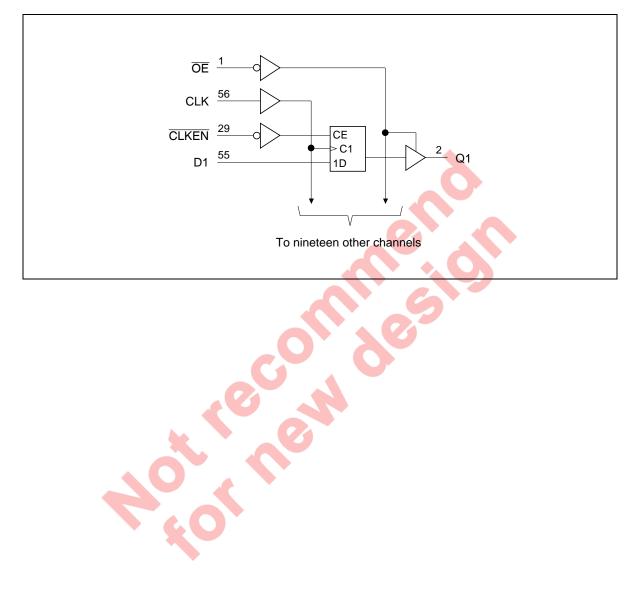
- 1. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

Item	Symbol	Min	Мах	Unit	Conditions	
Supply voltage	V <sub>cc</sub>	2.3	3.6	V		
Input voltage	V <sub>1</sub>	0	V <sub>cc</sub>	V		
Output voltage	Vo	0	V <sub>cc</sub>	V		
High level output current	I <sub>OH</sub>	_	-6	mA	A V <sub>CC</sub> = 2.3 V	
•		_	-8		$V_{CC}$ = 2.7 V	
		_	-12		V <sub>CC</sub> = 3.0 V	
Low level output current	I <sub>OL</sub>	_	6	mA	V <sub>CC</sub> = 2.3 V	
		_	8		$V_{CC}$ = 2.7 V	
		_	12		V <sub>CC</sub> = 3.0 V	
Input transition rise or fall rate	$\Delta t$ / $\Delta v$	0	10	ns / V		
Operating temperature	Та	-40	85	°C		

#### **Recommended Operating Conditions**

Note: Unused control inputs must be held high or low to prevent them from floating.

### Logic Diagram



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#### **Electrical Characteristics**

#### $(Ta = -40 \text{ to } 85^{\circ}C)$

Item	Symbol	$V_{cc}(V)$	Min	Max	Unit	Test Conditions
Input voltage	VIH	2.3 to 2.7	1.7		V	
		2.7 to 3.6	2.0	_	_	
	VIL	2.3 to 2.7	_	0.7	_	
		2.7 to 3.6	_	0.8	_	
Output voltage	V <sub>OH</sub>	Min to Max	V <sub>CC</sub> -0.2		V	I <sub>OH</sub> = –100 µA
		2.3	1.9	_	_	I <sub>OH</sub> = -4 mA, V <sub>IH</sub> = 1.7 V
		2.3	1.7	_		I <sub>OH</sub> = –6 mA, V <sub>IH</sub> = 1.7 V
		3.0	2.4			I <sub>OH</sub> = –6 mA, V <sub>IH</sub> = 2.0 V
		2.7	2.0	-		I <sub>OH</sub> = – <mark>8 mA, V<sub>IH</sub> = 2.0 V</mark>
		3.0	2.0	-		I <sub>OH</sub> = –12 mA, V <sub>IH</sub> = 2.0 V
	V <sub>OL</sub>	Min to Max		0.2		I <sub>0L</sub> = 100 μA
		2.3	-	0.4		I <sub>OL</sub> = 4 mA, V <sub>IL</sub> = 0.7 V
		2.3		0.55		I <sub>OL</sub> = 6 mA, V <sub>IL</sub> = 0.7 V
		3.0		0.55	5	I <sub>OL</sub> = 6 mA, V <sub>IL</sub> = 0.8 V
		2.7	2	0.6		I <sub>OL</sub> = 8 mA, V <sub>IL</sub> = 0.8 V
		3.0	-	0.8	_	$I_{OL}$ = 12 mA, $V_{IL}$ = 0.8 V
Input current	l <sub>IN</sub>	3.6	-	±5	μA	$V_{IN}$ = $V_{CC}$ or GND
	IIN (hold)	2.3	45	_	_	V <sub>IN</sub> = 0.7 V
		2.3	-45		_	V <sub>IN</sub> = 1.7 V
		3.0	75	_	_	V <sub>IN</sub> = 0.8 V
		3.0	-75	_	_	V <sub>IN</sub> = 2.0 V
		3.6	_	±500	_	V <sub>IN</sub> = 0 to 3.6 V
Off state output current *2	loz	3.6		±10	μA	V <sub>OUT</sub> = V <sub>CC</sub> or GND
Quiescent supply current	Icc	3.6	_	40	μA	$V_{IN} = V_{CC}$ or GND
	$\Delta I_{CC}$	3.0 to 3.6	_	750	μA	$V_{IN}$ = one input at (V <sub>CC</sub> –0.6) V, other inputs at V <sub>CC</sub> or GND

Notes: 1. For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

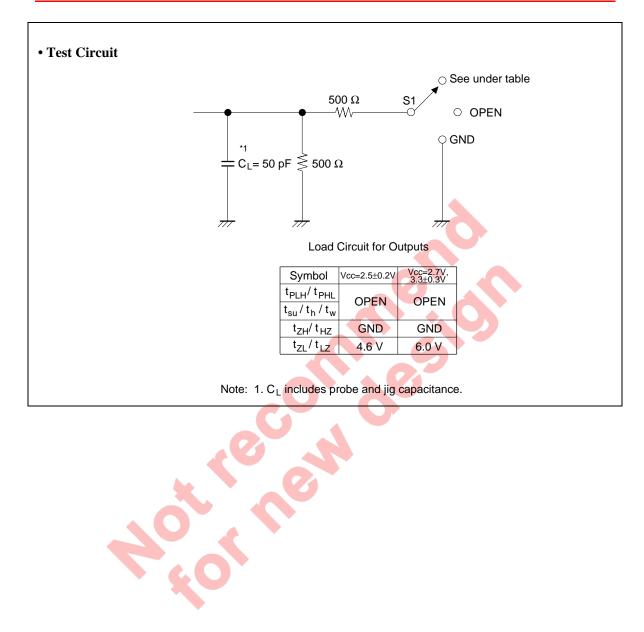
2. For I/O ports, the parameter  $I_{\text{OZ}}$  includes the input leakage current.

## **Switching Characteristics**

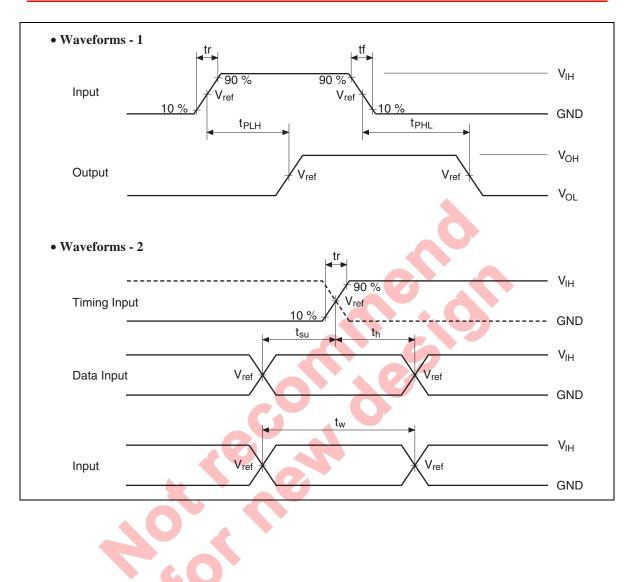
### $(Ta = -40 \text{ to } 85^{\circ}C)$

Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Unit	FROM (Input)	TO (Output)
Maximum clock frequency	f <sub>max</sub>	2.5±0.2	150	_	_	MHz		
		2.7	150	_	—			
		3.3±0.3	150	_	—			
Propagation delay time	t <sub>PLH</sub>	2.5±0.2	1.0	_	6.7	ns	CLK	Q
	t <sub>PHL</sub>	2.7	1.0	_	6.2			
		3.3±0.3	1.0	—	5.3			
Output enable time	t <sub>ZH</sub>	2.5±0.2	1.0	_	7.2	ns	OE	Q
	t <sub>ZL</sub>	2.7	1.0	_	7.0			
		3.3±0.3	1.0	-	5.8			
Output disable time	t <sub>HZ</sub>	2.5±0.2	1.0	-	6.3	ns	ŌĒ	Q
	t <sub>LZ</sub>	2.7	1.0		5.4			
		3.3±0.3	1.0	-	5.0			
Setup time	t <sub>su</sub>	2.5±0.2	4.0		67	ns	Data befo	re CLK↑
		2.7	3.6					
		3.3±0.3	3.1	_	_			
		2.5±0.2	3.4	—	_		CLKEN b	efore CLK↑
		2.7	3.1		_	_		
		3.3±0.3	2.7	_	_			
Hold time	t <sub>h</sub>	2.5±0.2	0	_	_	ns	Data after	CLK↑
		2.7	0	_	_	_		
		3.3±0.3	0	_	_	_		
		2.5±0.2	0	_	_	_	CLKEN at	fter CLK↑
		2.7	0	_	_			
		3.3±0.3	0	_	_	_		
Pulse width	tw	2.5±0.2	3.3		_	ns		
		2.7	3.3		_			
		3.3±0.3	3.3		_			
Input capacitance	CIN	3.3	_	3.5	_	pF		
Output capacitance	Co	3.3	_	7.0	_	рF		

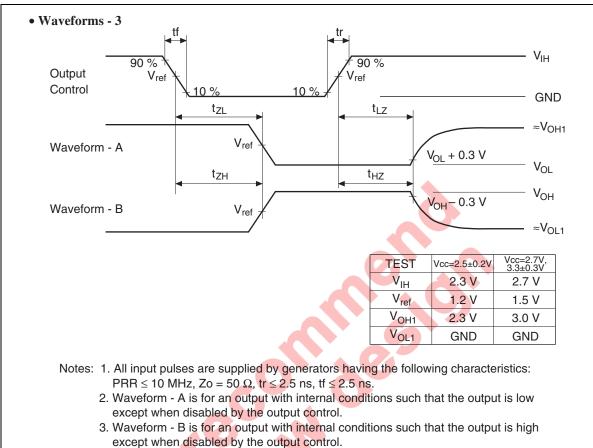








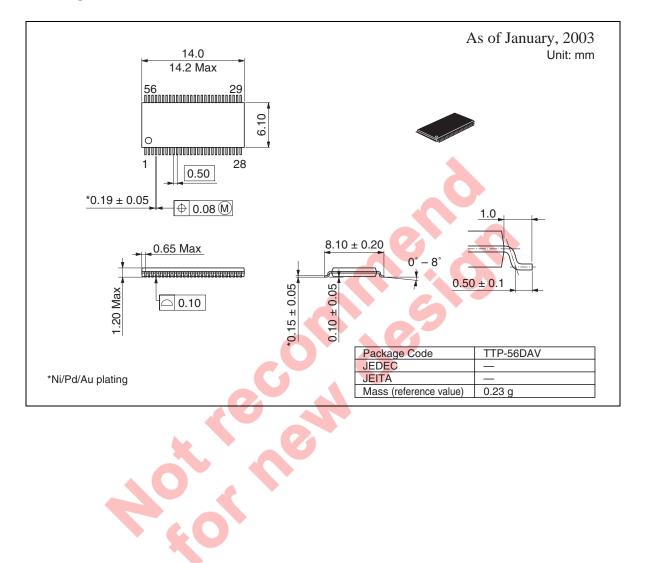




4. The output are measured one at a time with one transition per measurement.



### **Package Dimensions**





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